



COPY OF PAPERS
ORIGINALLY FILED

2815
✓

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Jack O. Chu Confirmation No.: 5389
Serial No.: 09/769,170 Group No.: 2815
Filed: January 25, 2001 Examiner: E.J. Wojciechowicz

For: A TRANSFERABLE DEVICE-CONTAINING LAYER
FOR SILICON-ON-INSULATOR APPLICATIONS

Commissioner for Patents
Washington, D.C. 20231

RECEIVED
JUN 13 2002
TECHNOLOGY CENTER 2800

CERTIFICATE OF MAILING UNDER 37 CFR 1.8 (a)

I hereby certify that the attached correspondence comprising:

1. Acknowledgment Post Card;
2. Petition and Fee for Extension of Time
(37 CFR 1.136(a)) (in duplicate); and
3. Response to a Requirement for Restriction Under 37 CFR
1.142

is being deposited with the United States Postal Service as first
class mail in an envelope addressed to:

Commissioner for Patents
Washington, D.C. 20231.

on May 23, 2002

Michelle Parra
(Type or printed name of person mailing paper or fee)

Michelle Parra
(Signature of person mailing paper or fee)

Attorney Docket No. YOR920000692US1